



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos Karnezos

Application No.: 10/618,933

Filed: July 14, 2003

Title: **Semiconductor multi-package module
including processor and memory package
assemblies**

) Examiner: Alonzo Chambliss

) Group Art Unit: 2827

) Date: September 9, 2005

) CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on September 9, 2005.

Signed

Bill Kennedy

MAIL STOP AMENDMENT
COMMISSIONER FOR PATENTS
P.O. BOX 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office action mailed March 9, 2005, kindly amend the application as follows.

Amendments to the claims are reflected in the **Listing of Claims**, which begins on page 2 of this paper.

Amendments to the Specification begin on page 10 of this paper.

Amendments to the Drawings begin on page 12 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks begin on page 13 of this paper.

An **Appendix** including amended drawing figures is attached following page 18 of this paper.